

RF Simulation Basics

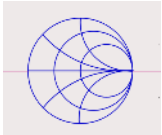
Agenda



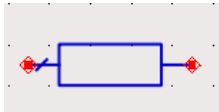
– Introduction



– Applications



– S-Parameter Simulations – a closer look



– Models: The building blocks for effective simulations



– Simulation Engines

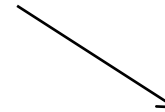
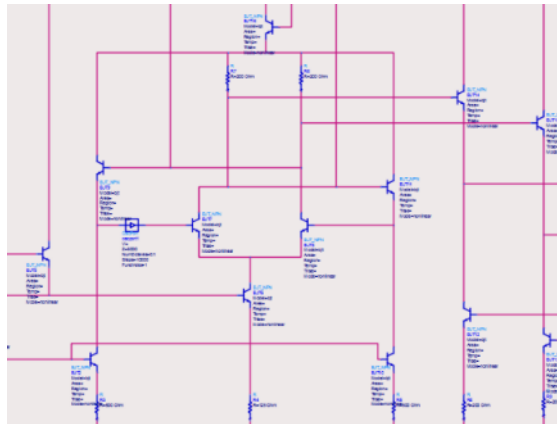
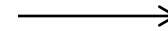
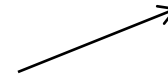
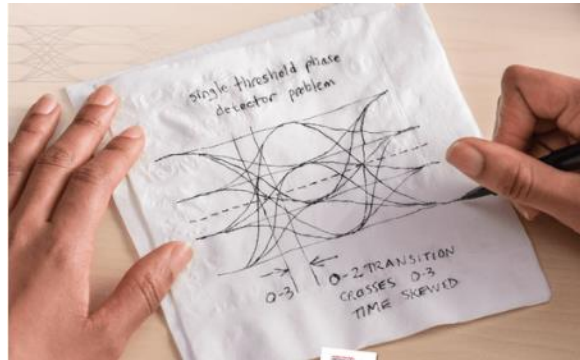
Introduction



Electronic Design Automation (EDA)



IDEA



PRODUCT

CONCEPT | DESIGN

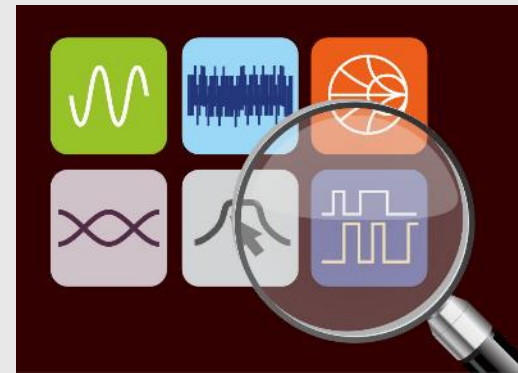
Do you need to perform RF simulations?

If you encounter any of these phrases, you probably do.

- Maxwell's Equations
- Antenna
- Distributed Circuit
- Physical Layer design
- High Frequency
- Radio Frequency (RF)
- Microwave (uW)
- Power Amplifier
- LoadPull
- SourcePull
- X Band
- Ku Band
- Wearables
- IoT
- Matching Networks
- Impedance Matching
- Smith Chart
- S-Parameters
- S21/S11
- ACPR/ACLR
- Noise Figure
- Radiation
- EMI/EMC
- Gain
- Return Loss
- TOI
- IP3
- P1dBc
- EVM

Applications

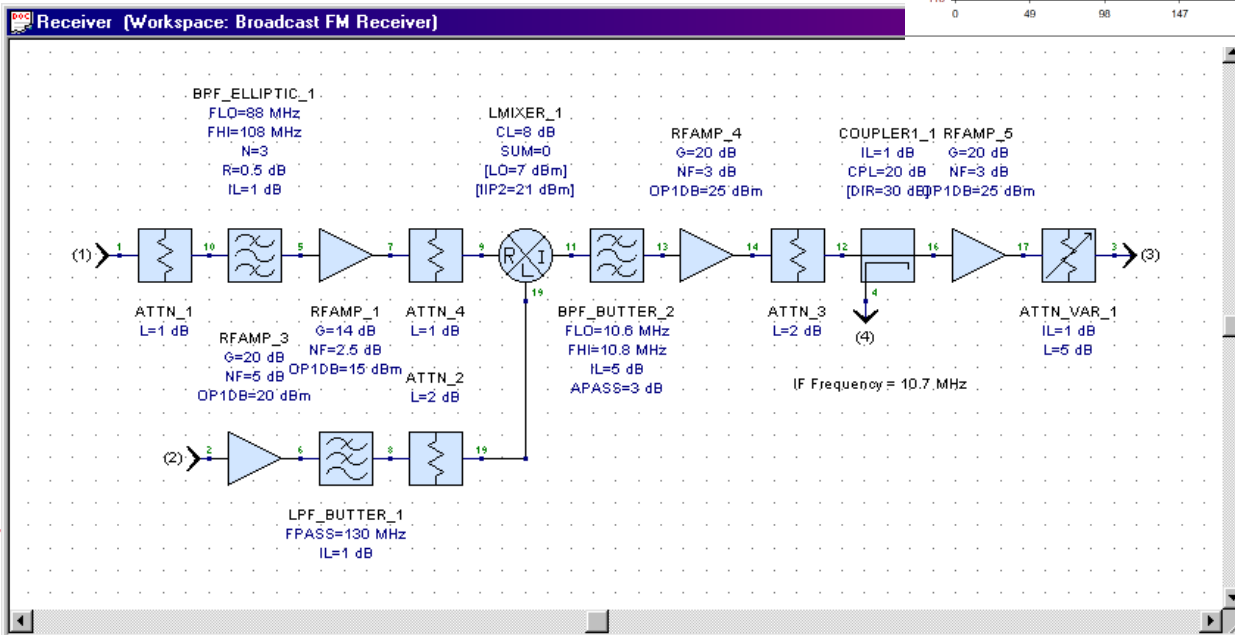
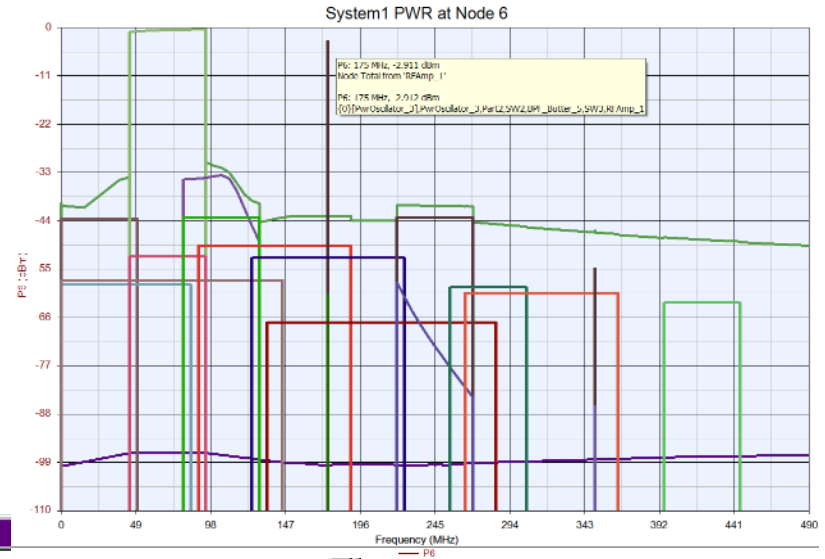
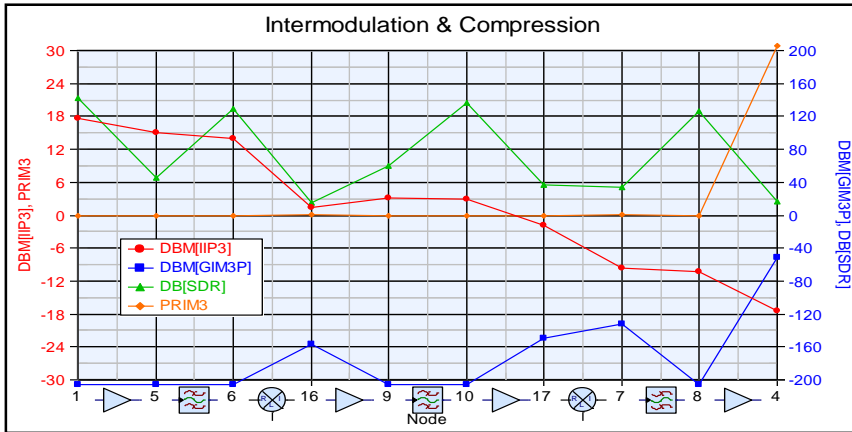
What could you achieve if you could do RF simulations?





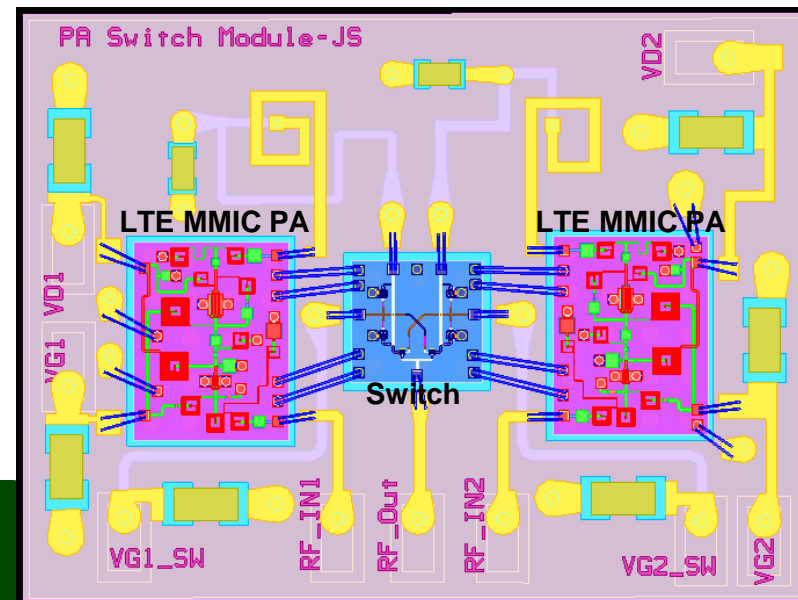
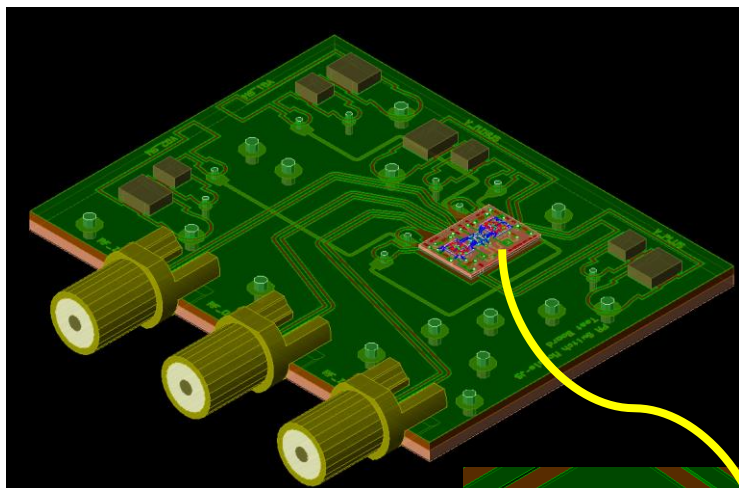
RF System performance

Simulating your car's FM radio



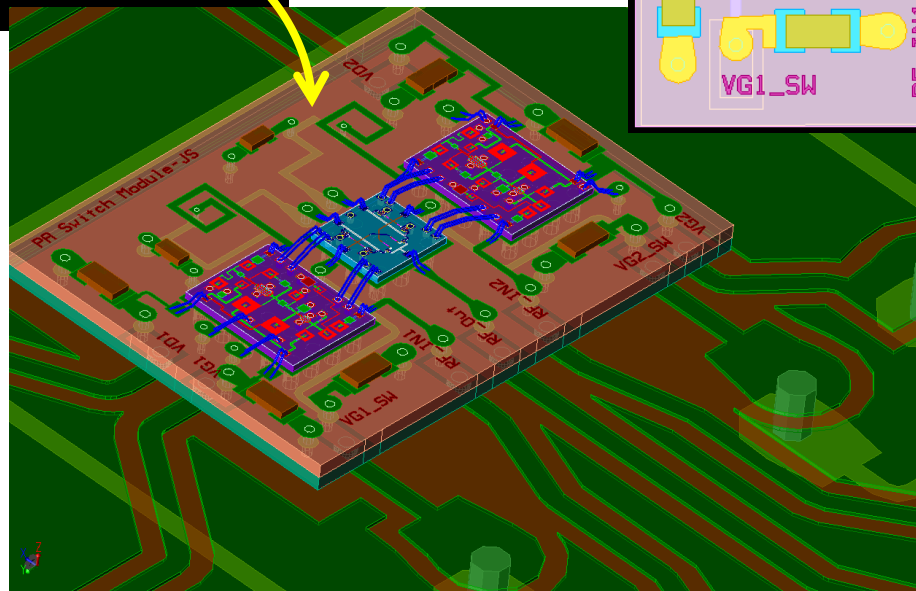
Multi Chip RF Front End Modules

Powering smart phones/tablets



The Complete PA / Switch Multi-Chip Module

- PA / Switch IC's
- Bond wires
- Laminate board
- Solder bumps
- PCB test board
- Connectors

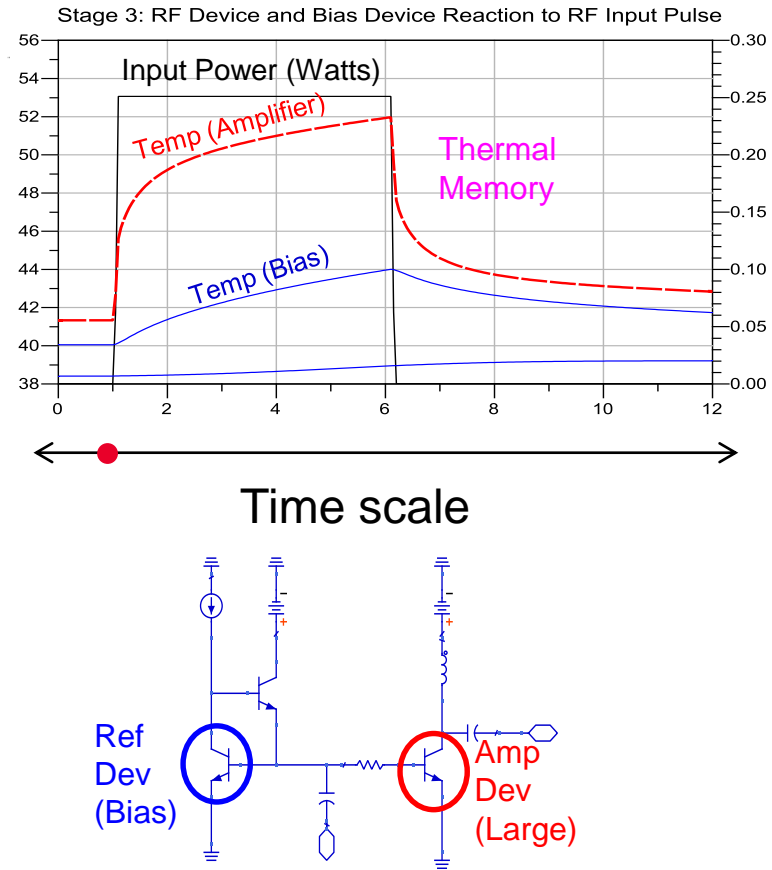
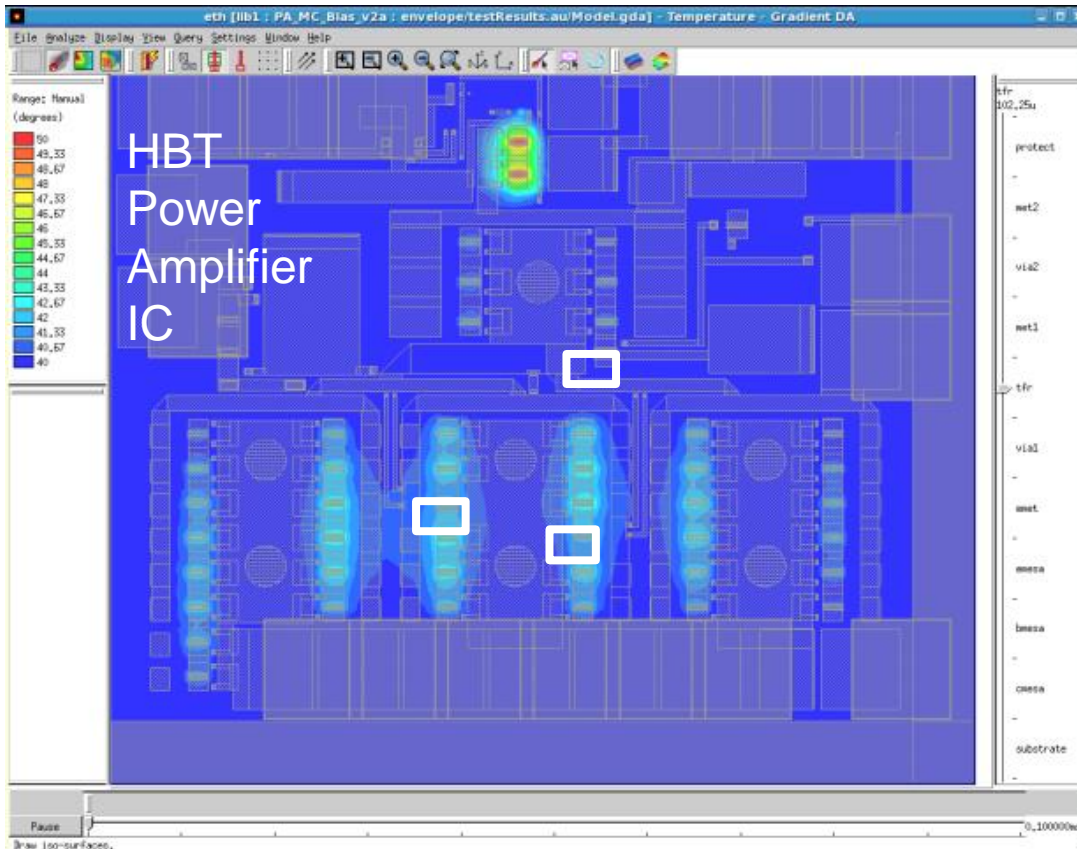


Laminate Board with PA / Switch IC's



Electro-Thermal Simulation

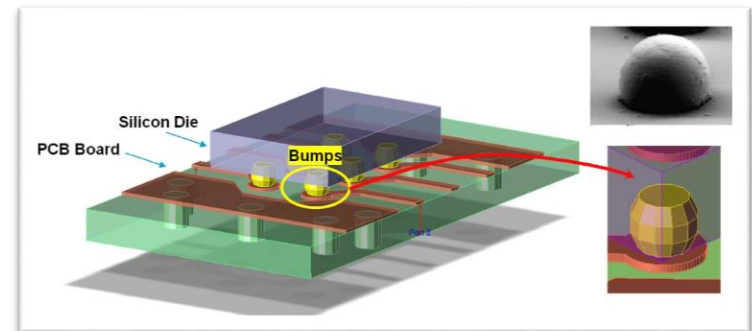
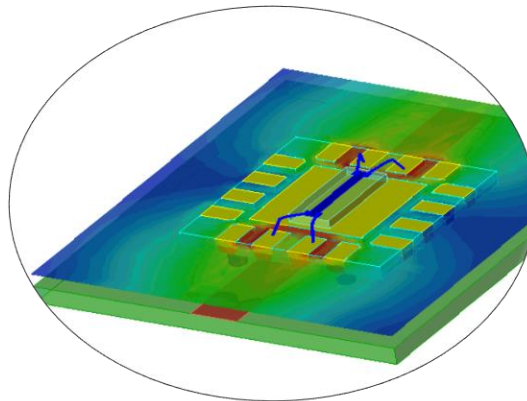
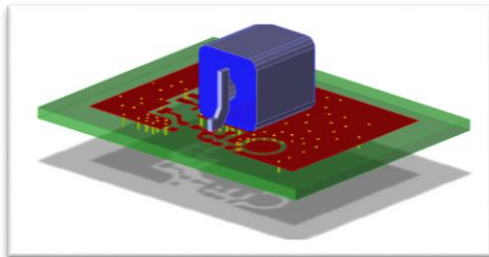
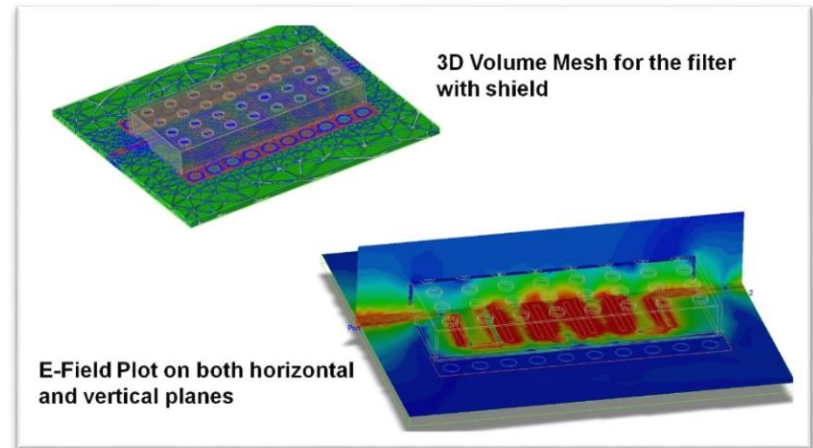
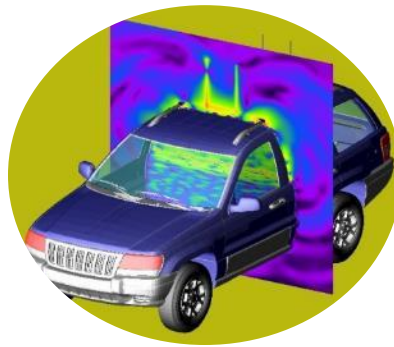
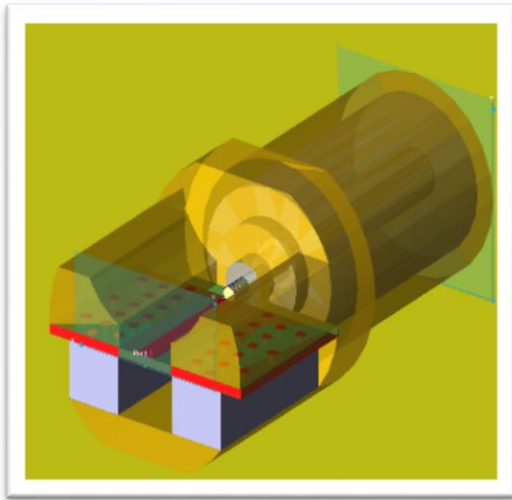
Dynamic thermal behavior





Electromagnetic Analysis

Signal Propagation in arbitrary structures

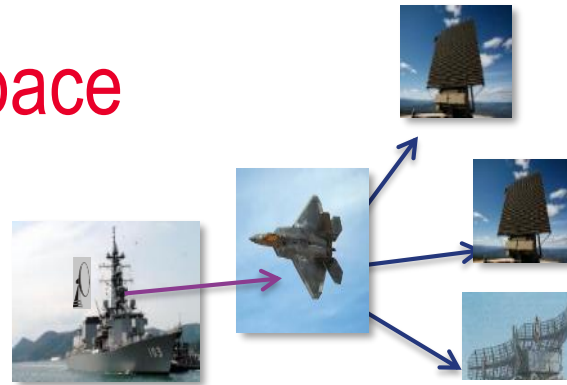


Electronic Warfare / Aerospace



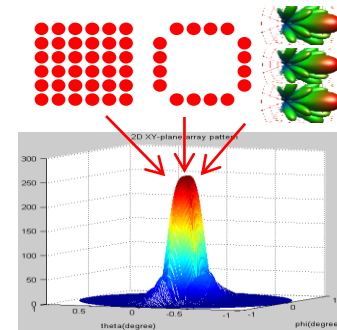
3D Scenario Modeling

- Model multiple moving TX and RX platforms including clutter and environment



Phased Array Degradations

- Model beamforming & jamming performance at the system level



Satcom Dynamic Channel Modeling

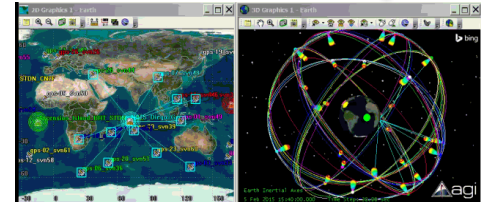


Atmospheric, Terrain, Doppler, Delay



RF/MW CIRCUITS

MEASURED X,S-PARAMS

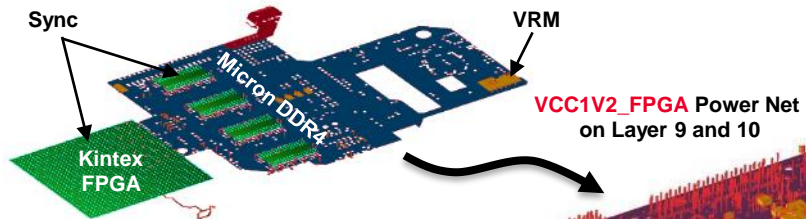
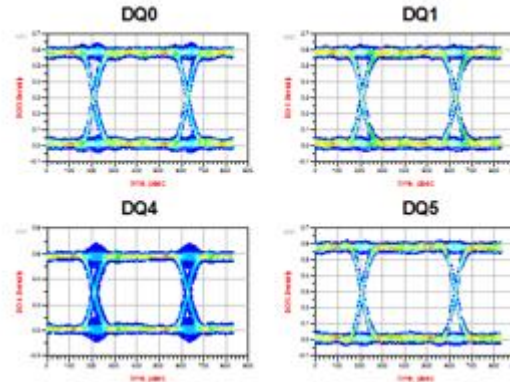
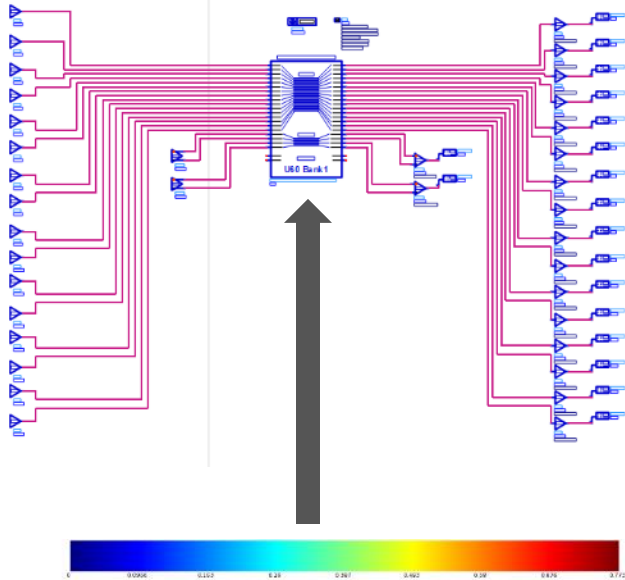




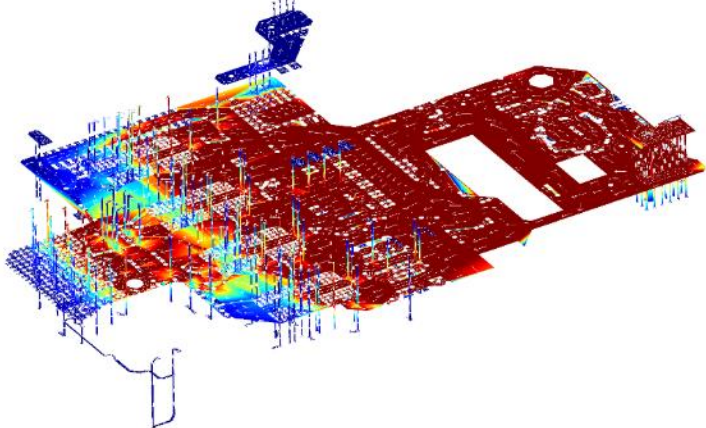
DDR4 Memory

Signal Integrity and Power Integrity

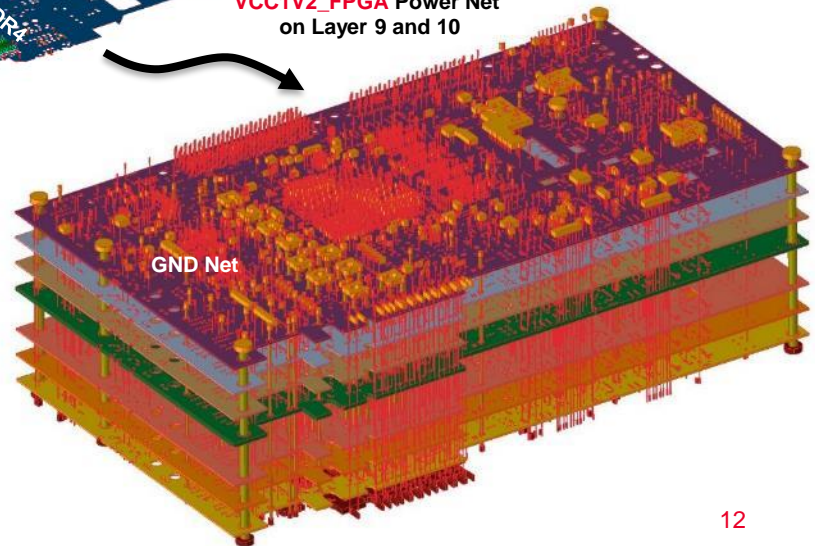
DDR4 Bank 1 DQ and DQs DDR Bus Simulation ~ 16 min



VCC1V2_FPGA Power Net on Layer 9 and 10

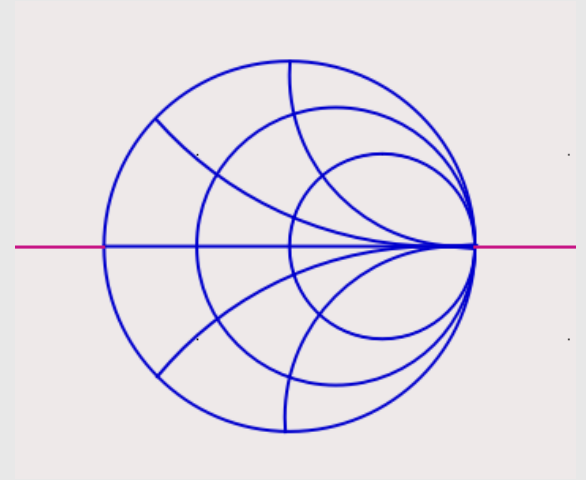


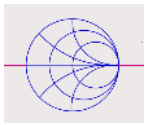
50x scaled



S-Parameter Simulations

A closer look





S Parameter Simulations

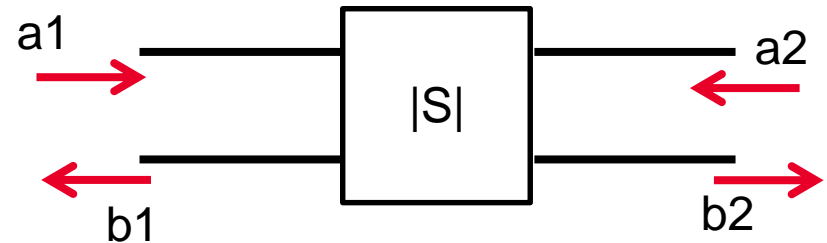
You already learned about S Parameters. But how does one simulate S- Parameters in an EDA tool?

$$S_{11} = \frac{\text{Reflected}}{\text{Incident}} = \frac{b_1}{a_1} \Big|_{a_2=0}$$

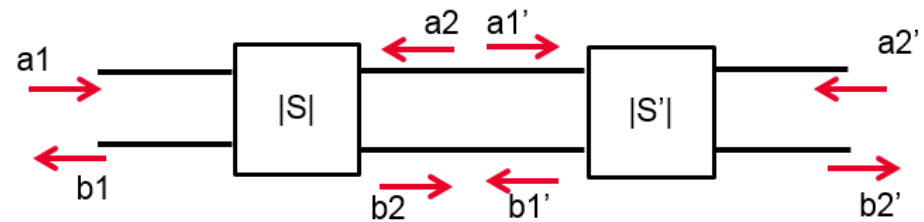
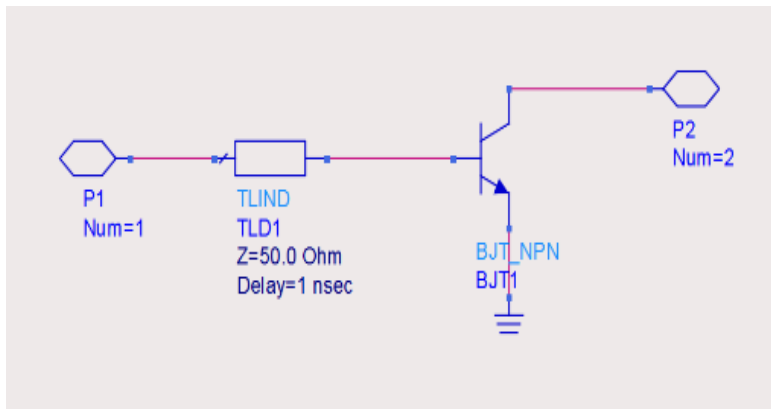
$$S_{21} = \frac{\text{Transmitted}}{\text{Incident}} = \frac{b_2}{a_1} \Big|_{a_2=0}$$

$$S_{22} = \frac{\text{Reflected}}{\text{Incident}} = \frac{b_2}{a_2} \Big|_{a_1=0}$$

$$S_{12} = \frac{\text{Transmitted}}{\text{Incident}} = \frac{b_1}{a_2} \Big|_{a_1=0}$$



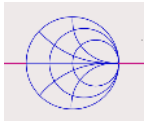
Should we employ matrix math to cascade S-Parameters?



For Cascaded S Matrix $a_1'=b_2$ and $a_2=b_1'$
 $b_1=S_{11}*a_1+S_{12}*a_2=S_{11}a_1+S_{12}*b_1'$ where $b_1'=S_{11}'*a_1'+S_{12}'*a_2'$
 substituting yields, $b_1=S_{11}*a_1+S_{12}*S_{11}'*a_1'+S_{12}*S_{12}'*a_2'$ eq 1
 $a_1'=b_2=S_{21}*a_1+S_{22}*a_2$ where $a_2=b_1'$ substituting and rearranging yields,
 $a_1'=(S_{21}*a_1+S_{22}*S_{12}'*a_2')/1-S_{22}*S_{11}$ eq 2 then eq 2 into eq 1,

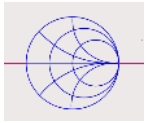
Repeating for b_2' results in cascaded S-Parameter

$$\begin{bmatrix} b_1 \\ b_2' \end{bmatrix} = \begin{bmatrix} S_{11} + \frac{S_{12}*S_{11}'+S_{21}}{1-S_{22}*S_{11}'} & \frac{S_{12}*S_{12}'}{1-S_{22}*S_{11}'} \\ \frac{S_{21}*S_{21}'}{1-S_{22}*S_{11}'} & S_{22} + \frac{S_{22}*S_{12}'+S_{21}'}{1-S_{22}*S_{11}'} \end{bmatrix} * \begin{bmatrix} a_1 \\ a_2' \end{bmatrix}$$



S-Parameter Simulation

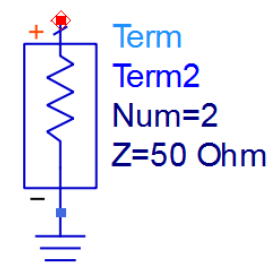
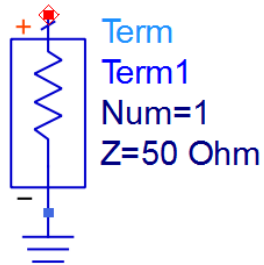
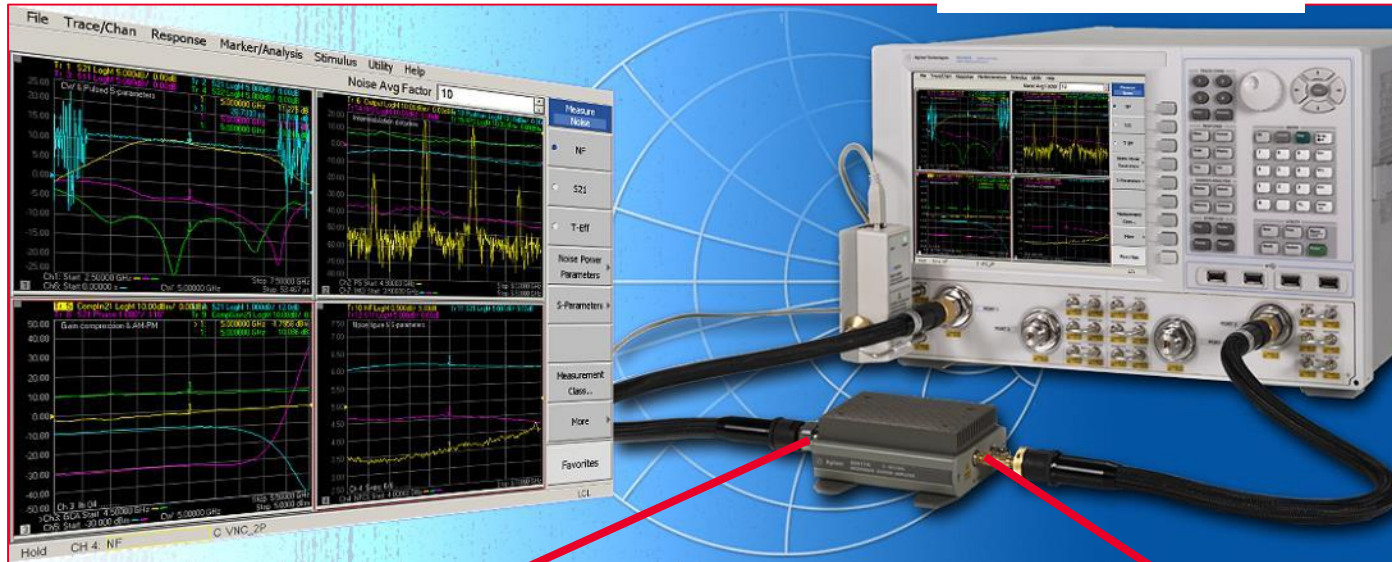
- Matrix math runs out of steam if you have bigger complicated designs.
- Modern Simulators actually behave similar to Network analyzers. Excite one “end” of the circuit (at certain frequencies) and measure incident and reflected waves at the same “end” and also at other “ends”.
- Then compute ratios and get S-Parameters.
- For this to work, the EDA tool needs to know how each device (transmission line, capacitor, transistor, etc..) reacts to RF excitation.
- EDA tools contain built-in models to represent the most common devices. (More on device models later)
- And you can supplement the built-in models with measurement based models too.

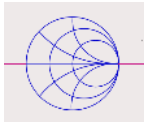


S-Parameter Simulation

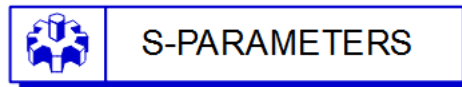
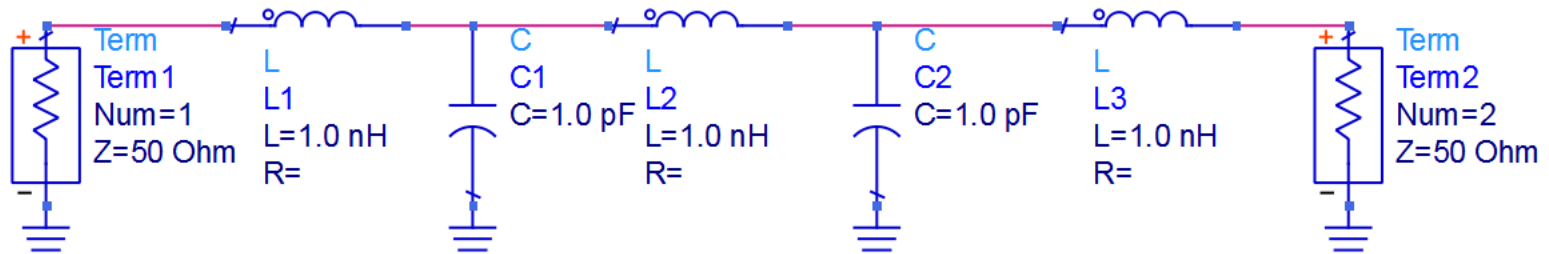
 S-PARAMETERS

S_Param
SP1
Start=1.0 GHz
Stop=10.0 GHz
Step=0.1 GHz



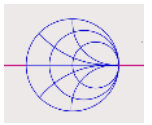


S-Parameter Simulation

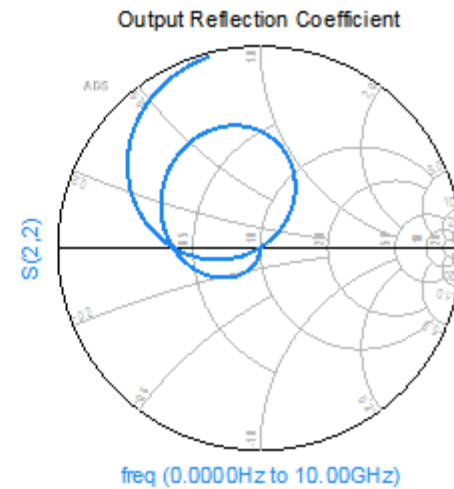
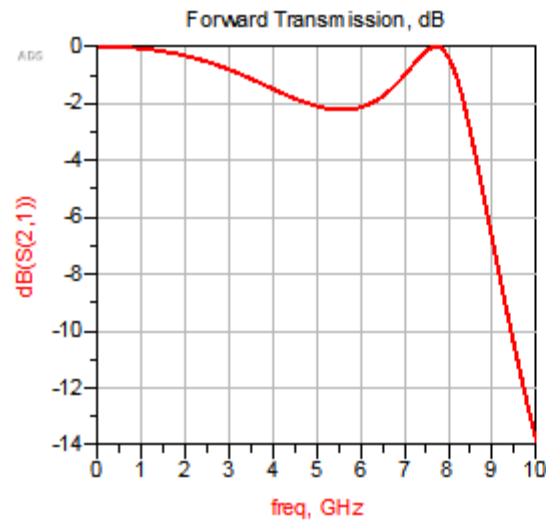
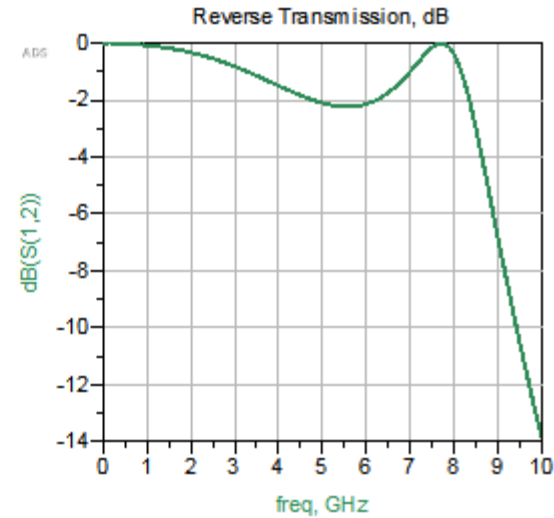
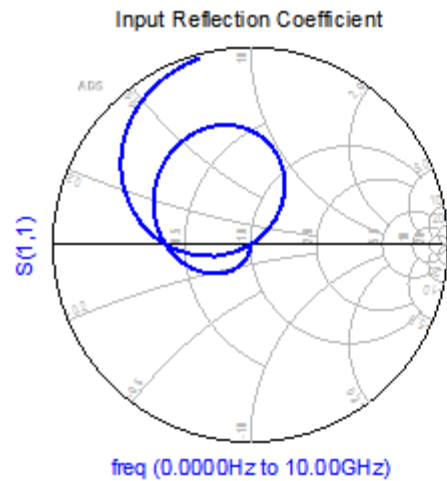


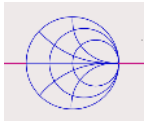
S_Param
SP1
Start=1.0 GHz
Stop=10.0 GHz
Step=0.1 GHz

Port Count is not limited
No Calibration needed
Impedance can be any value

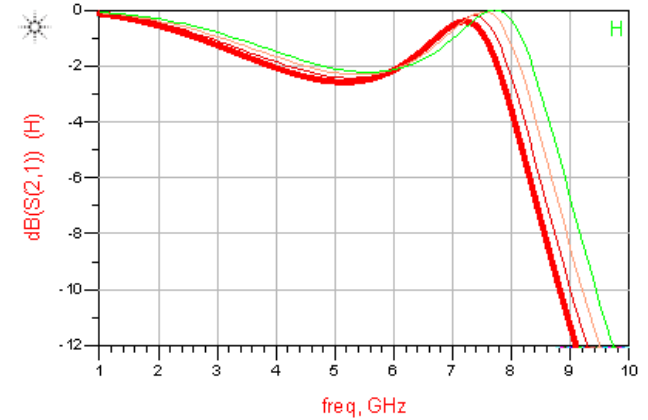
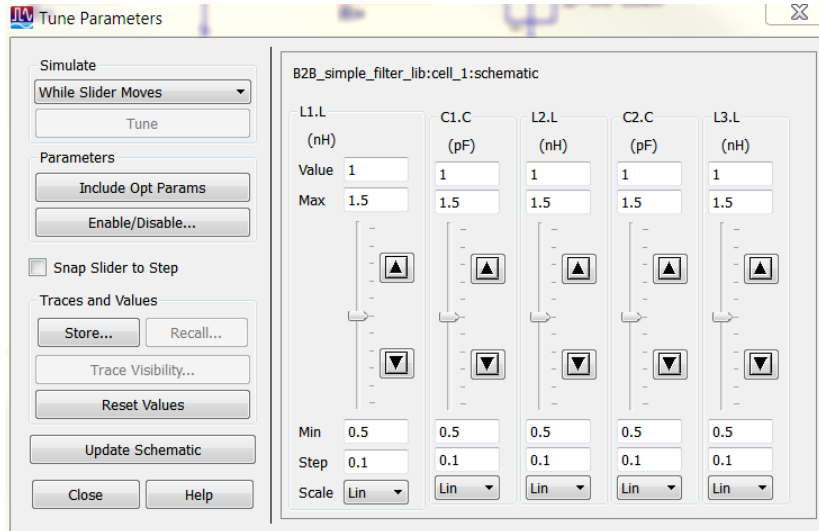
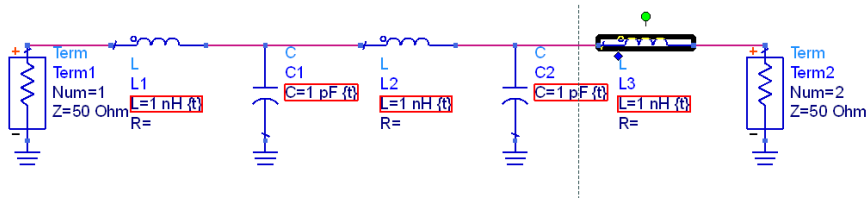


Simulation Results



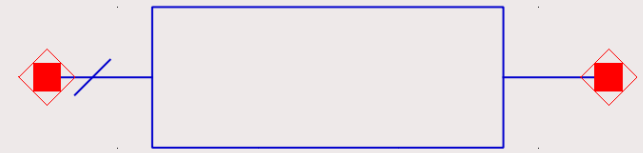


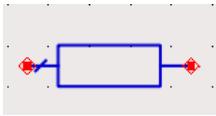
Tune & Optimize— What if scenarios



Models

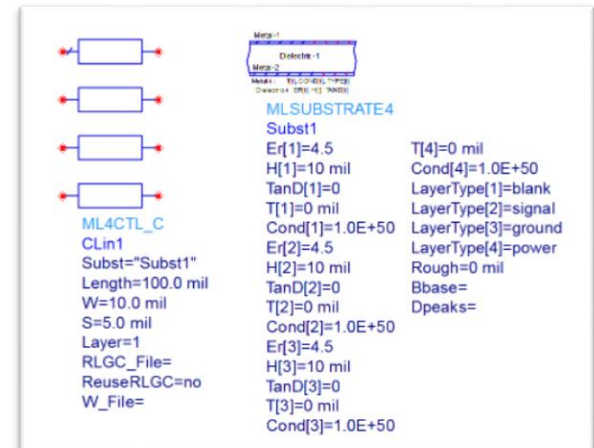
The building blocks for effective simulations



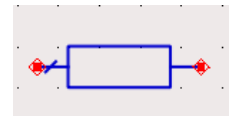


Models

- Previously we saw that “models” are required to represent transmission lines, transistors, capacitors etc.
- Devices that are linear in nature (resistors, transmission lines) have linear models.
- Devices that are non linear in nature (diodes, transistors) have both linear and non-linear models.
- Models can be ideal or more realistic

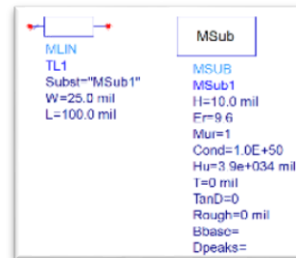


Models



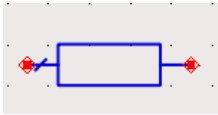
– Models are typically based on important works of research. For e.g. the MLIN model:

- W. J. Getsinger, "Measurement and Modeling of the Apparent Characteristic Impedance of Microstrip," *MTT-31*, August 1983.
- E. Hammerstad and O. Jensen, "Accurate Models for Microstrip Computer-aided Design," *MTT Symposium Digest*, 1980.



– The research is translated into equations and then implemented in the EDA tool.

– Models have a working “range”. For e.g. MLIN model is not expected to work at 1 THz.



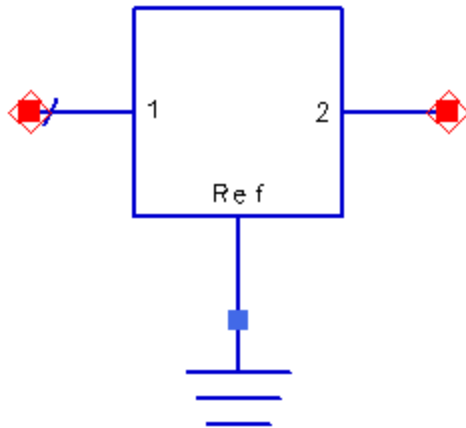
Models

Measured or Simulated S-Parameters

S2P

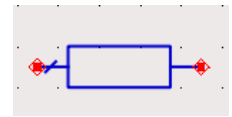
SNP1

File="ina-0286.s2p"



INA-02186 S PARAMETERS												
Id = 35 mA LAST UPDATED 07-22-92												
#	ghz	s	ma	r	50							
0.01	.09	-178	37.38	-1	.010	1	.24	-1				
0.05	.09	-172	37.55	-6	.013	11	.24	-5				
0.10	.11	-160	37.46	-13	.011	8	.23	-9				
0.20	.14	-153	37.04	-25	.009	15	.22	-17				
0.30	.18	-156	36.62	-37	.012	1	.21	-25				
0.40	.22	-161	36.20	-49	.013	28	.19	-30				
0.50	.25	-169	35.70	-61	.011	42	.18	-35				
0.60	.28	-177	34.94	-74	.012	44	.16	-39				
0.80	.31	165	32.93	-101	.015	52	.15	-47				
1.00	.30	148	27.26	-129	.019	57	.12	-59				
1.20	.27	135	22.26	-153	.024	62	.09	-70				
1.40	.24	129	17.22	-173	.028	61	.07	-80				
1.60	.21	128	13.27	170	.027	62	.04	-82				
1.80	.20	129	10.44	156	.035	61	.02	-83				
2.00	.20	131	8.34	144	.035	63	.01	-20				
2.50	.23	133	5.29	123	.044	59	.02	30				
3.00	.27	130	3.61	103	.052	63	.02	27				
3.50	.31	124	2.60	86	.060	64	.02	34				
4.00	.34	118	2.02	70	.068	58	.01	3				

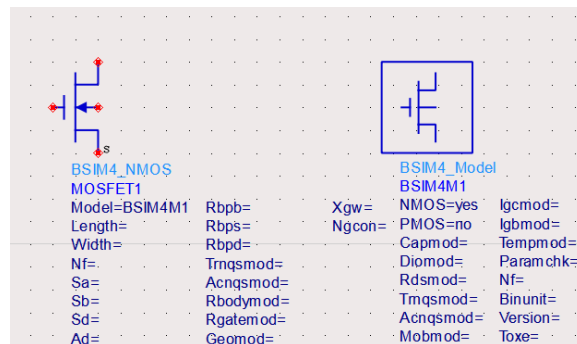
Modeling Linear Behavior Using S-parameters

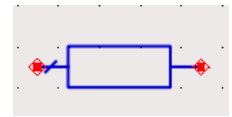


Models

Nonlinear models for transistors

- Non linear models are based on complex differential equations. Research groups (e.g. BSIM group at University of California, Berkeley) develop these models and share with the industry.
- By feeding the right parameter values in the model “card” you can match the software model to a real world device.
- The parameter values are typically obtained by measurements and “fitting” algorithms.
- Typically takes several PhDs to do this right.

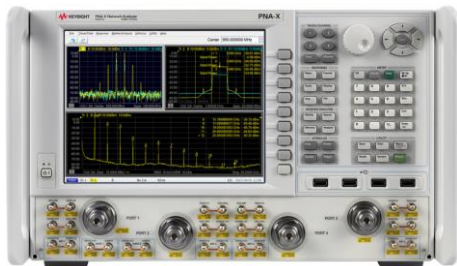




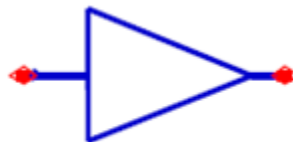
What are X-Parameters?

- X-parameters are the mathematically correct superset of S-parameters, applicable to both large-signal and small-signal conditions, for linear and nonlinear components. *The math exists!*
- We can measure, model, & simulate with X-parameters
- Each part of the puzzle has been created
- The pieces now fit together seamlessly

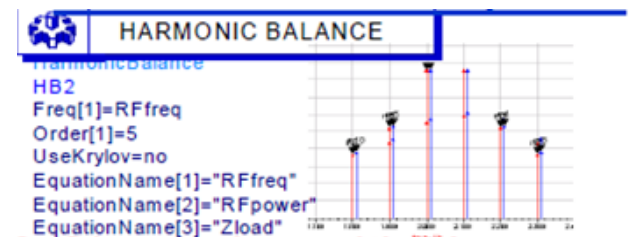
NVNA: Measure X-parameters



PHD: X-parameter block



ADS: Simulate X-parameters

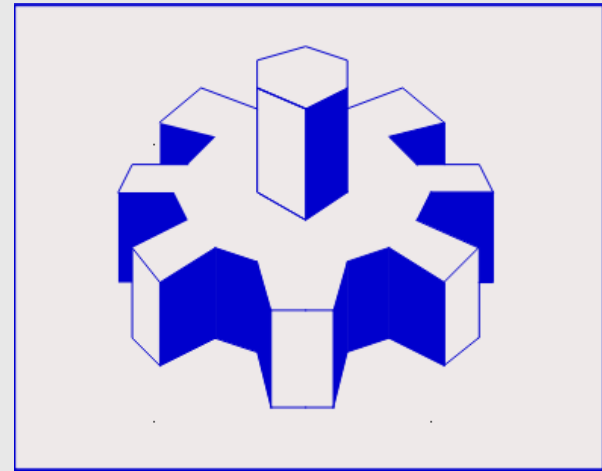


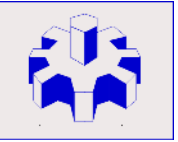
Interoperable Nonlinear Measurement, Modeling & Simulation with X-parameters

“X-parameters have the potential to do for characterization, modeling, and design of nonlinear components and systems what linear S-parameters do for linear components & systems”

Simulation Engines

Analyze your RF design





Simulation Types

- Frequency vs Time
- Linear vs Non-Linear
- Circuit vs System
- Circuit vs EM
- Multi-Physics (Electrical Circuit + Thermal)



Simulation Engines

- DC
- AC
- S-Parameter
- Harmonic Balance
- Transient (High Frequency Spice)
 - Channel Sim
- Circuit Envelope
- EM Simulation
 - MoM
 - FEM
 - FDTD
- Spectral
- Data Flow
- ElectroThermal

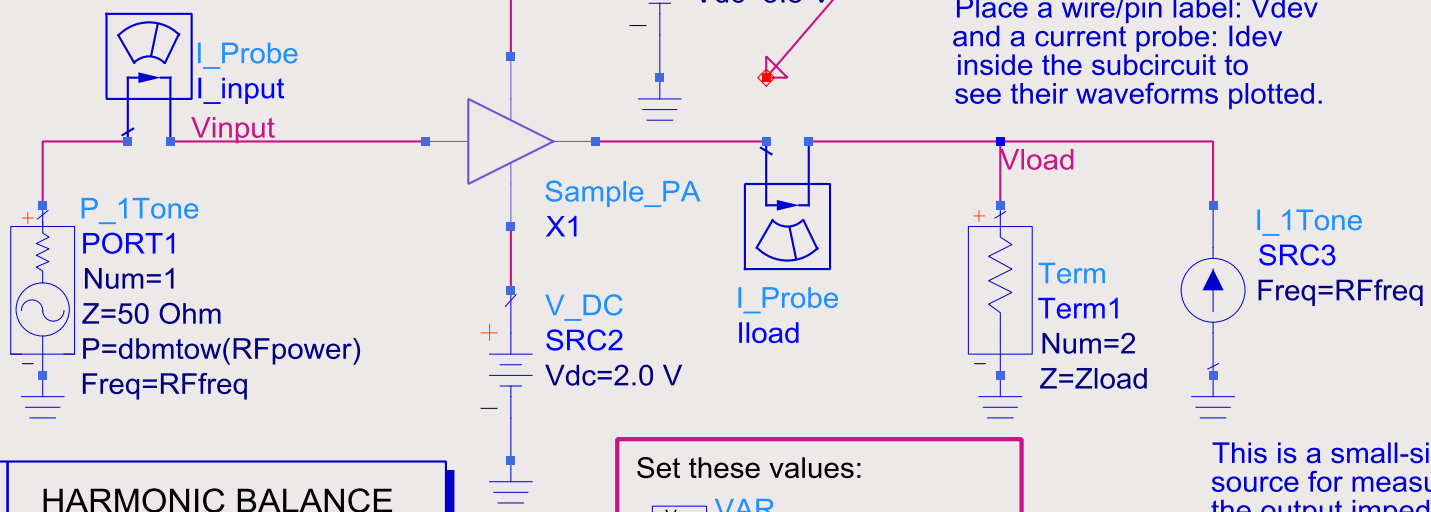


Harmonic Balance Setup

One Tone Harmonic Balance Simulation at one input frequency and power.

This is a sample amplifier. To simulate your amplifier, first push into this subcircuit and "paste" or insert your schematic into it.

Place a wire/pin label: Vdev and a current probe: Idev inside the subcircuit to see their waveforms plotted.



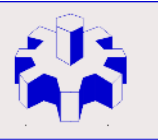
HARMONIC BALANCE

Set these values:
 $\begin{matrix} \text{Var} \\ \text{Eqn} \end{matrix}$ **VAR**
 $\begin{matrix} \text{Var} \\ \text{Eqn} \end{matrix}$ **VAR1**
RFfreq=850 MHz
RFpower=10_dBm
Zload=50

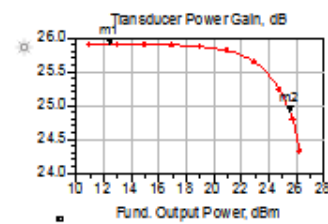
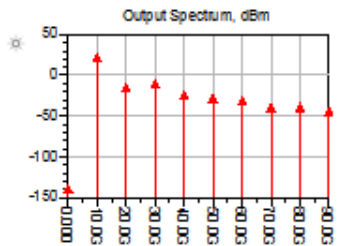
HarmonicBalance
HB1
Freq[1]=RFfreq
Order[1]=5

This is a small-signal source for measuring the output impedance.
 $\begin{matrix} \text{Meas} \\ \text{Eqn} \end{matrix}$ **MeasEqn**
Power_Calcs

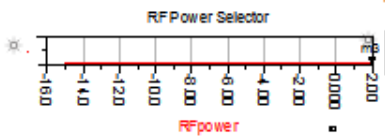
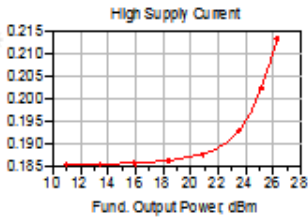
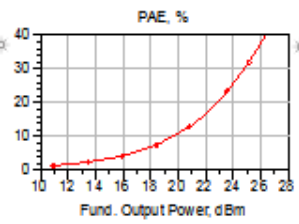
HB1Tone



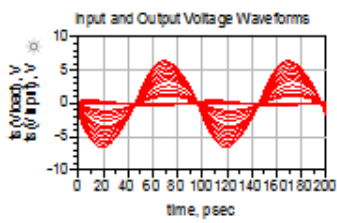
Harmonic Balance Results



Gain Compression between markers, dB
 1.003
 Output Power at Marker m2, dBm
 25.51

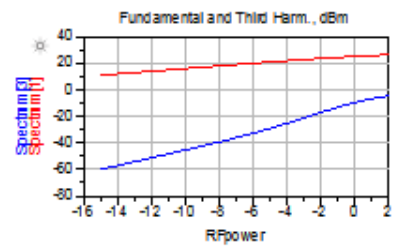


Move Marker m3 to update output spectrum plot.



Equations are on the "Equations" page. AM-to-AM, AM-to-PM plots are on "AM-to-AM, AM-to-PM plots" page.

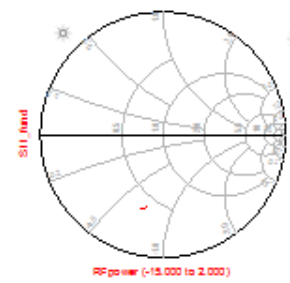
Fundamental Frequency	Available Source Power dBm	Fundamental Output Power dBm	Transducer Power Gain	Power-Added Efficiency, %	DC Power Consumpt. Watts	High Supply Current	The total Dissipation Watts
10.000	-15.000	10.906	25.906	1.326	0.928	0.188	0.915
10.000	-12.500	13.405	25.905	2.357	0.928	0.188	0.906
10.000	-10.000	15.901	25.901	4.184	0.929	0.188	0.890
10.000	-7.500	18.385	25.885	7.390	0.932	0.188	0.863
10.000	-5.000	20.822	25.822	12.854	0.938	0.188	0.818
10.000	-4.000	21.766	25.766	15.883	0.944	0.189	0.794
10.000	-3.000	22.679	25.679	19.426	0.952	0.190	0.767
10.000	-2.000	23.549	25.549	23.408	0.966	0.193	0.739
10.000	-1.000	24.360	25.360	27.649	0.985	0.197	0.713
10.000	0.000	25.104	25.104	31.948	1.012	0.202	0.688
10.000	1.000	25.770	24.770	36.190	1.041	0.208	0.664
10.000	2.000	26.266	24.266	39.566	1.067	0.213	0.644



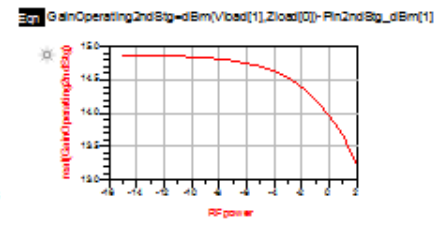
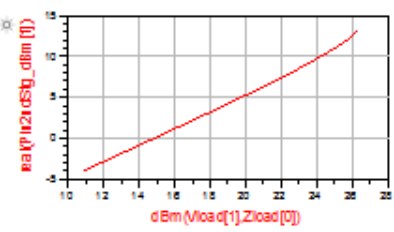
Available Source Power dBm	Second Harmonic dBc	Third Harmonic dBc	Fourth Harmonic dBc	Fifth Harmonic dBc
-15.00	-44.81	-70.97	-83.89	-103.5
-12.50	-42.58	-66.12	-78.27	-105.0
-10.00	-40.43	-61.24	-72.75	-100.8
-7.500	-38.26	-56.23	-67.53	-99.33
-5.000	-36.27	-50.03	-61.08	-88.75
-4.000	-35.71	-47.08	-57.87	-85.13
-3.000	-35.44	-43.89	-54.37	-81.65
-2.000	-35.60	-40.84	-50.84	-78.38
-1.000	-36.35	-37.51	-47.61	-65.56
0.0000	-37.45	-34.77	-45.23	-53.46
1.000	-37.64	-32.65	-44.33	-51.47
2.000	-35.84	-30.90	-45.29	-48.68

```

[Eq] Pin2ndStg=0.5*real(Vin2ndStg*conj(IIn2ndStg))
[Eq] Pin2ndStg_dBm=10*log(Pin2ndStg)+30
[Eq] ZIn_fund=Vinput[1]/Iinput[1]
[Eq] S11_fund=Zin_fund-50/(Zin_fund+50)
  
```

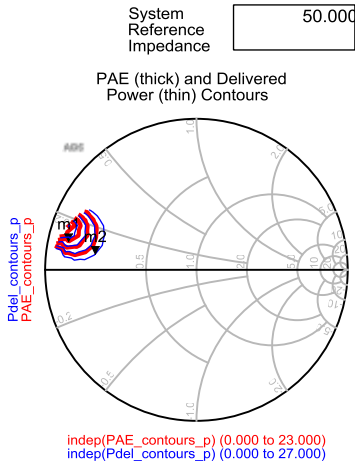


RF power (-15.000 to 2.000)



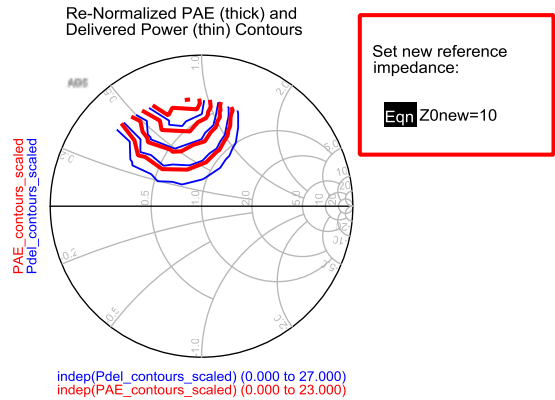


Harmonic Balance Load Pull Typical Results



Set Delivered Power contour step size (dB) and PAE contour step size (%), and number of contour lines

$\text{Eqn} \text{ Pdel_step}=0.5$
 $\text{Eqn} \text{ PAE_step}=4$
 $\text{Eqn} \text{ NumPAE_lines}=5$
 $\text{Eqn} \text{ NumPdel_lines}=5$



Set new reference impedance:

$\text{Eqn} \text{ Z0new}=10$

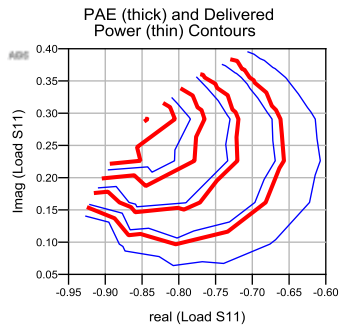
Maximum Power-Added Efficiency, %

Maximum Power Delivered, dBm

m1
 $\text{indep}(m1)=7$
 $\text{PAE_contours_p}=0.865 / 167.515$
 $\text{level}=36.510, \text{number}=1$
 $\text{impedance} = \text{Z0} * (0.073 + j0.109)$

m2
 $\text{indep}(m2)=17$
 $\text{Pdel_contours_p}=0.676 / 171.170$
 $\text{level}=29.929, \text{number}=1$
 $\text{impedance} = \text{Z0} * (0.194 + j0.074)$

Equations are on the "Equations" page.



Simulated Source Impedances and Input Reflection Coefficients

Move Marker m3 to select load impedance value. Corresponding PAE, delivered power, input reflection coefficient and impedance values will be updated.

Impedance at marker m3

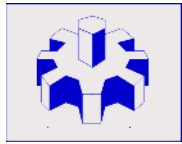
PAE, % Power Delivered (dBm)

Input Reflection Coefficient

Input Impedance

m3
 $\text{real_index}11=0.889$
 $\text{surface_samples}=0.917 / 165.728$
 $\text{imag_index}11=0.226$
 $\text{impedance} = \text{Z0} * (0.044 + j0.125)$

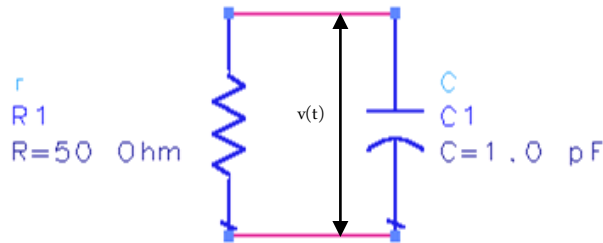
$\text{real_index}11 (-0.949 \text{ to } -0.051)$



Transient Analysis

Just like SPICE, only better

- Kirchoff's current equations are derived at each node in differential form



$$\frac{v(t)}{R} + C \frac{dv(t)}{dt} = 0 \quad (1)$$

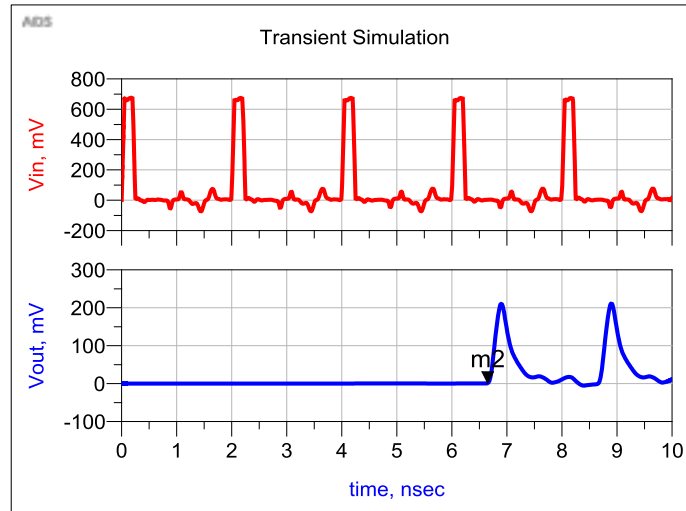
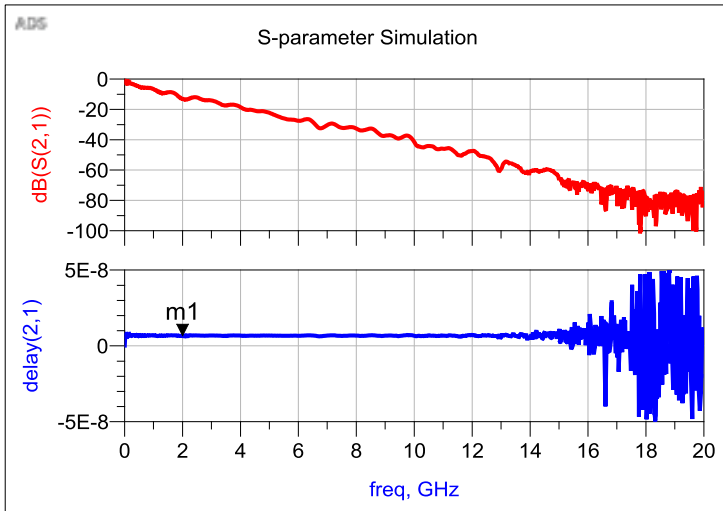
- The time derivatives are replaced with discrete-time approximations (integration)
- The solution, in the case of a complex circuit, will consist of a system of nonlinear equations which is solved using the Newton-Raphson method



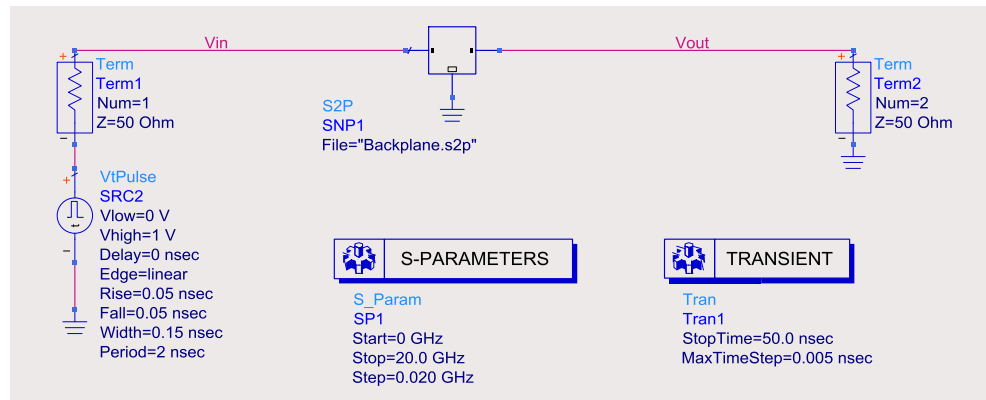
Transient Simulation

m1
freq=2.000GHz
delay(2,1)=6.685E-9

m2
time=6.651nsec
Vout=0.001



Delay calculated from measured S-parameters (as group delay) corresponds very well with delay observed in Transient simulation. Note the clearly causal response and good behavior even when using somewhat non-ideal measured data.

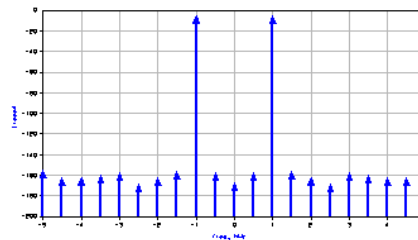
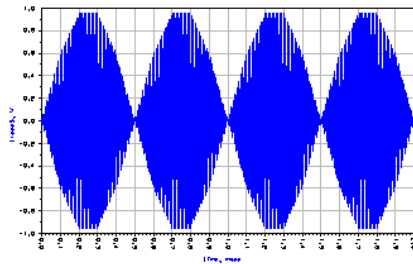


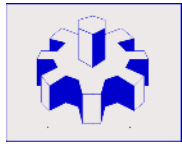


Circuit Envelope

Beyond CW and onto Modulated signals.

- Time samples the modulation envelope (not carrier)
- Compute the spectrum at each time sample
- Output a time-varying spectrum
- Use equations on the data
- Faster than HB or Spice in many cases
- Integrates with System Simulations & Keysight's Ptolemy

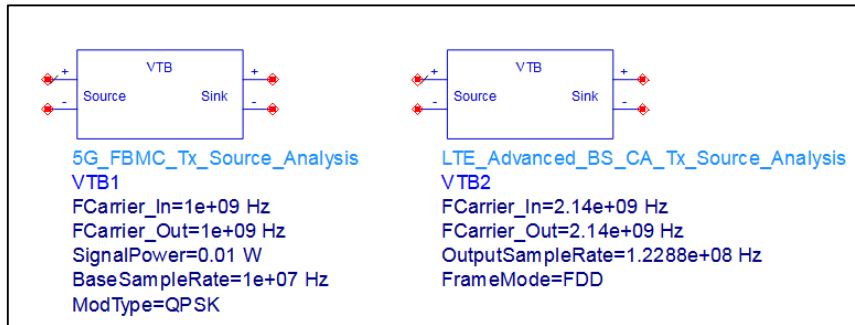




Circuit Envelope

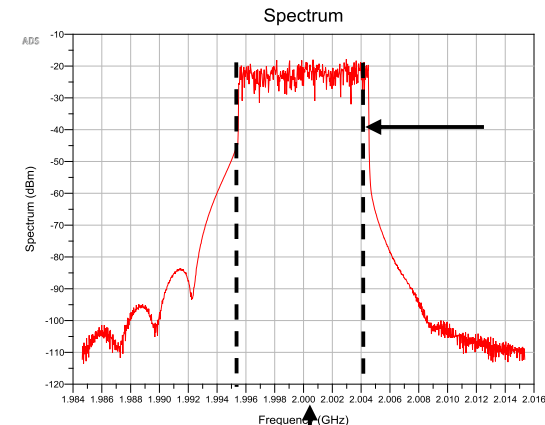
Test Circuits with Realistic Signals

LTE, LTE-A, 802.11ac, BTLE, 5G



Example CE results:

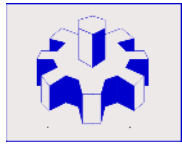
LTE DL



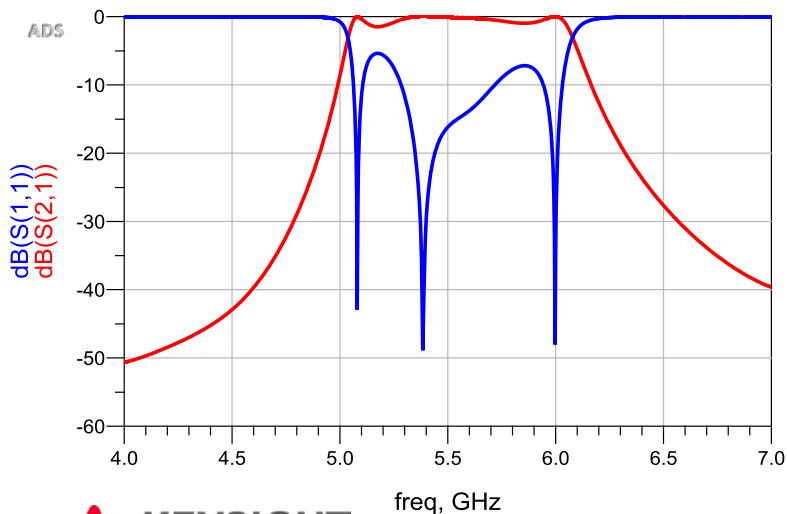
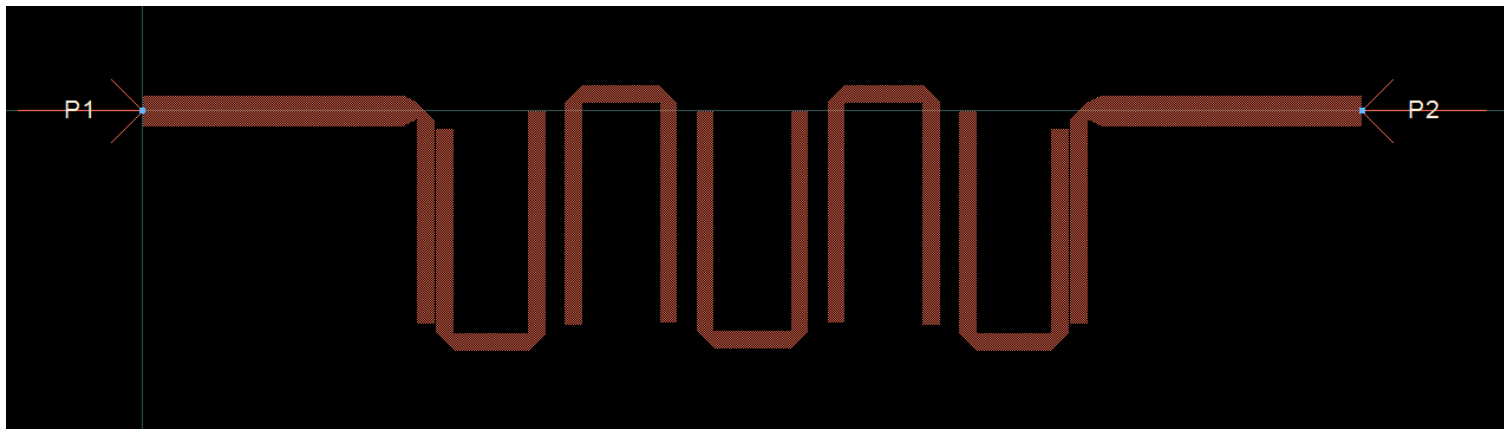
2 GHz carrier

Simulations can include:

- Adjacent Channel Power Ratio
- Noise Power Ratio
- Error Vector Magnitude
- Power Added Efficiency
- Bit Error Rate



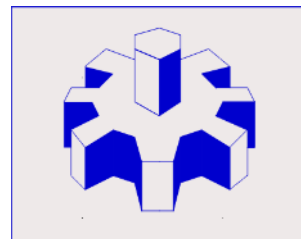
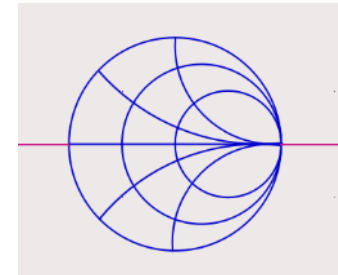
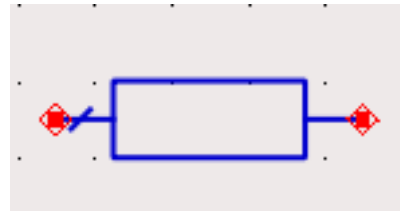
Electromagnetic Method of Moments solver



- No good Circuit model exists
- Physical dimensions and properties are known.
- The entire geometry is “meshed”
- Results are S Parameters
- Design can be optimized

Summary

Start with your great idea, choose your EDA environment, use appropriate models to construct the designs. Run simulations to verify performance and build great RF applications.



Learn more about RF Simulations

- How to Design an RF Power Amplifier and other How-to videos:

<https://www.youtube.com/playlist?list=PLtq84kH8xZ9HIYgBYDsP7TbqBpftidzI8>

- For More Information www.keysight.com/find/eesof-ads-info

- ADS on



www.keysight.com/find/eesof-ads-videos

- Genesys on



https://www.youtube.com/playlist?list=PLtq84kH8xZ9E8S_y5dmCXtJFPo14NsCtt